

WORLD INTELLECTUAL PROPERTY ORGANIZATION International Bureau



INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(51) International Patent Classification 5:		11) International Publication Number: WO 93/1514
C08L 23/08, C08K 3/04 C08L 101/00, C08J 5/18	A1	43) International Publication Date: 5 August 1993 (05.08.9)
(21) International Application Number: PCT/US (22) International Filing Date: 20 August 1992		mours and Company, Legal/Patent Records Center
(30) Priority data: PCT/US92/00830 3 February 1992 (03.02.5 (34) Countries for which the regional or international application	92) N	(81) Designated States: CA, JP, KR, European patent (AT, B) CH, DE, DK, ES, FR, GB, GR, IE, IT, LU, MC, N SE).
was filed: 873,178 24 April 1992 (24.04.92)	AT et	S Published With international search report.
(71) Applicant: E.I. DU PONT DE NEMOURS AN PANY [US/US]; 1007 Market Street, Wilmin 19898 (US).	ND CC	[- E
(72) Inventor: HUANG, Hua-Feng; 306 Longwood Chadds Ford, PA 19317 (US).	ood Dr	2,

(54) Title: ELECTRICALLY DISSIPATIVE COMPOSITE

(57) Abstract

Q.

A heat-sealable, oil-resistant, static-dissipative packaging composite consisting essentially of 95.5-97.5 wt % ionomer and 4.5-2.5 wt % electroconductive carbon powder having a surface area of 1000-1500 m²/gm and a pore volume of 480-510 ml/100 gm. The composite is useful for protective packaging of electrostatic sensitive electronic components and assemblies.

FOR THE PURPOSES OF INFORMATION ONLY

Codes used to identify States party to the PCT on the front pages of pamphlets publishing international applications under the PCT.

AT AU BB BE BF BG BJ BR CA CF CG CH CS CZ DE ES FI	Austria Australia Barbados Belgium Burkina Faso Bulgaria Benin Brazil Canada Central African Republic Congo Switzerland Côte d'Ivoire Canteroon Czechoslovakia Czech Republic Germany Denmark Spain Fintand	FR GA GB GN GR HU IE IT JP KP KR LJ LK IJ LK IJ MC MG MI	France Gabon United Kingdom Guinea Greere Hungary Ireland Italy Japan Democratic People's Republic of Korea Republic of Korea Kazakhstan Licchtenstein Sri Lanka Luxembourg Monaco Madagascar Mali Mongolia	MR MW NL NO NZ PL PT RO RU SD SE SK SN TD TG UA US VN	Mauritania Malawi Malawi Netherlands Norway New Zealand Poland Portugal Romania Russian Federation Sudan Sweden Slovak Republic Senegal Soviet Union Chad Togo Ukraine United States of America Vict Nam
--	---	--	---	---	--

PCT/US92/06805

1 TITLE

ELECTRICALLY DISSIPATIVE COMPOSITE

CROSS REFERENCE TO RELATED APPLICATION

This application is a continuation-in-part of copending U.S. Application, Serial No. 07/649,109, filed February 1, 1991.

10

5

FIELD OF THE INVENTION

This invention relates to composites useful as electrostatic-dissipative, flexible barrier materials.

15

BACKGROUND OF THE INVENTION

Functional failures or manufacturability impairments of electronic components or assemblies are often attributable to damage caused by electrostatic 20 discharge, electrostatic field force, electromagnetic radiation, moisture, oil and/or corrosive gases encountered during storage, shipment and/or processing. The problem has increased in severity in recent years, and will continue to worsen. The current trend in 25 electronic devices and systems is towards miniaturization like VLSI (Very Large Scale Integration) chip technology. These smaller devices are more sensitive to corrosion and electrostatic damage. Yet, the demand for greater reliability is increasing. 30 Accordingly, protection of electronic devices and systems is needed to preserve their functionality during storage, shipment and processing.

15

A packaging material for electrostatic discharge, electromagnetic radiation, and moisture-proof protection is disclosed by Mondano in U.S. Patent 3,572,499. An aluminum foil moisture barrier, a heat-sealable carbonfilled polyethylene inner layer and a nonwoven protective outer layer are laminated together to form the Mondano packaging material. The carbon-filled polyethylene inner layer, however, will delaminate from the aluminum foil and absorb oil when contacted by oil. Additionally, excessive carbon will contaminate the parts enclosed in the package by carbon transfer and will degrade the heat seal seam strength if the layer contains carbon sufficient to achieve static-dissipative electrical surface resistivity of between 10^5 and 10^{12} ohms per square. If the carbon loading in the polyethylene is reduced to obtain sufficient heat seal seam strength, the surface resistivity exceeds 10^{12} ohms per square and the inner surface of the package is no longer static-dissipative.

Thus, there is a need for an oil-resistant, heat sealable, humidity insensitive, electrostatic-dissipative material for packaging electronic devices and systems. It is an object of the invention to provide composites useful as heat-sealable, oil-resistant, low contamination, humidity insensitive, electrostatic-dissipative, flexible materials for packaging electrostatic discharge sensitive (ESDS) items such as microcircuits, sensitive semiconductor devices, sensitive resistors and associated higher assemblies.

SUMMARY OF THE INVENTION

The invention relates to an electrically dissipative composite free of any blowing agent and consisting

PCT/US92/06805 WO 93/15142

3

essentially of 97.5-95.5 wt % ionically cross-linked thermoplastic polymer and 2.5-4.5 wt % electroconductive carbon powder having a surface area of $1000-1500 \text{ m}^2/\text{gm}$ and a pore volume of 480-510 ml/100 gm.

In a further aspect, the invention relates to an electrically dissipative package comprising a continuous, heat-sealable, flexible sheet of the above composite and optionally, a continuous layer of metal foil. In packages comprising a composite layer and a metal foil layer, the composite layer is adhered to the face of the metal foil layer that constitutes the inner surface of the package.

DETAILED DESCRIPTION OF THE INVENTION

5

10

15 Ionically cross-linked thermoplastic polymers or ionomers are the substrate polymer used in this invention. Preferred ionomers are ethylene organic acid copolymers partly neutralized with metallic ions such as potassium, lithium, sodium and zinc. Particularly 20 preferred ionomers are disclosed by Rees in U.S. Patent 3,264,272 and sold under the name Surlyn® by E. I. du Pont de Nemours and Company (Wilmington, DE). These Rees ionomers comprise a polymer of an α -olefin having the general formula RCH=CH2 where R is a radical selected from the class consisting of hydrogen and alkyl 25 radicals having from 1 to 8 carbon atoms, the olefin content of said polymer being at least 50 mol percent based on the polymer, and an α , β -ethylenically unsaturated carboxylic acid having 1 or 2 carboxylic 30 acid groups, the acid monomer content of said polymer being from 0.2 to 25 mol percent based on the polymer, said carboxylic-acid containing polymer containing uniformly distributed throughout the polymer, one or

more metal ions having ionized valences of 1 to 3 inclusive where the acid comonomer is monocarboxylic, and an ionized valence of one where the acid comonomer is dicarboxylic, the quantity of the metal ion being sufficient to neutralize at least 10 percent of the carboxylic acid.

The electroconductive carbon powder used in the invention has a surface area of 1000-1500 m²/gm and a pore volume of 480-510 ml/100 gm. Preferably, the carbon powder has a surface area of about 1250 m²/gm and a pore volume of about 495 ml/100 gm. Particularly preferred is Ketjenblack® EC600JD, marketed by Akzo Chemie America (Chicago, IL).

When the weight percent loading of the carbon powders used in this invention falls below 5 in common 15 base polymers such as EVA (ethylene-vinyl acetate), ABS (acrylonitrile-butadiene-styrene), HDPE (high density polyethylene), LDPE (low density polyethylene), and SBR (styrene-rubber), the electrical volume resistivity rises steeply. Therefore, these carbon powders have not 20 been used in static-dissipative thermoplastic materials which require a thin film (i.e., 0.5 mil-5 mils) surface resistivity in the range of 10^5 to 10^{12} ohms per square. Also, when a blowing agent is present in the composite, the final structure being a foam, a carbon weight 25 percent in the composite of less than 5 likewise has a surface resistivity greater than the 10^5 to 10^{12} ohms per square range. Nonetheless, applicants have found that when an ionomer resin is compounded with 2.5-4.5 wt 30 % of the carbon powder of this invention, particularly Ketjenblack® EC600JD, the two components work together to enable better control of the surface resistivity of the final-blend non-foamed film (e.g., 0.5 mil-5 mils) to within the static dissipative range (e.g., 10^5 to 10^{12}

PCT/US92/06805 WO 93/15142

5

ohms per square, more preferably 106 to 1010 ohms per square at or below an ambient humidity of 12%). Carbon particle emission and transfer when rubbed against a clean surface is also substantially reduced. It was surprising that the ionomer/carbon compositions of the invention had such advantageous properties in the absence of elemental metal, such as copper.

The ionomer resin and carbon powder can be compounded by blending with a twin-screw extruder, a continuous mixer, or a batch mixer to achieve thorough mixing at a melt temperature of 160°-195°C. A low blending melt temperature tends to yield poor dispersion of carbon into the ionomer resin resulting in slightly higher volume resistivity. The melt index of the ionomer resin should be selected so that the melt index of the blended resin/carbon falls in the range of 1-20 decigrams/min.

10

15

25

30

Monolayer packaging material comprising a resin and carbon powder film can be produced by extruding a resin/carbon blend into a film. Typically, the blend is - 20 extruded at a melt temperature of 180°-240°C. Extrusion at melt temperatures higher than 240°C can overheat the carbon particles causing blisters or streaks in the film surface. Extrusion at temperatures lower than 180°C produces films having unsatisfactorily high electrical resistivities. The resultant film has oil resistance, humidity insensitivity, low contamination, permanent electrostatic-dissipative functional performance and superior heat-sealability. "Permanent electrostatic dissipative functional performance" means that films of this invention do not lose their static dissipative performance, as compared to films which have volatile organic antistatic additives. Superior heat-sealability is characterized by a wider range of heat seal

temperatures (e.g., 160°-200°C) and a seam strength of greater than 1590 grams/inch.

Multilayer packaging material can be produced by a number of different methods. In one method an intermediate or adhesive layer of ionomer resin is extruded at a melt temperature of 240°-300°C between an ionomer/carbon blend film and a metal foil or metal foil laminate using an extrusion laminator. An extrusion melt temperature lower than 240°C will result in inadequate bond strength between the foil and the film. An extrusion melt temperature above 300°C will cause resin degradation.

In another method, multilayer packaging material can be produced by laminating at a lamination interface temperature of 80°-160°C an ionomer/carbon film with an intermediate layer of ionomer film onto a surface of a metal foil or a metal foil laminate by passing the webs through a heated nip in a thermal laminator. A lamination interface temperature of less than 80°C results in inadequate bond strength between the foil and the film. A lamination interface temperature of greater than 160°C causes the preblended ionomer/carbon film to melt thereby deteriorating the surface resistivity of the film.

A third method produces multilayer packaging material by the sequential appplication of the ionomer adhesive layer and the ionomer/carbon blend composite. An adhesive layer of the ionomer resin at a melt temperature of 240 - 300°C can be extruded directly on to a metal foil or metal foil laminate followed by the extrusion of a surface layer of ionomer/carbon blend composite at a melt temperature of 180 - 240°C.

In a fourth method, multilayer packaging material can be produced by coextruding a coating of

WO 93/15142 PCT/US92/06805

7

ionomer/carbon blend composite with an adhesive layer of ionomer resin directly on to a metal foil or metal foil laminate, using sufficient temperature and pressure to adhere the coating without degrading the surface resistivity of the resultant laminate.

And in yet another method, multilayer packaging material can be produced by extrusion coating an ionomer/carbon blend composite directly on to a metal foil or metal foil laminate, using sufficient temperature and pressure to adhere the composite directly to the foil without the need for an intermediate or adhesive layer.

The metal foil imparts to the packaging laminate EMI (electromagnetic interference) shielding and moisture vapor barrier properties. A metal foil 15 laminate comprises a metal foil layer having secured to one face a layer of protective material which ultimately forms the outside of the package. The layer of protective material may be any material suitable for protecting the metal layer and giving strength and body to the packaging laminate. Examples of protective material include woven, knitted, extruded or nonwoven sheets such as Kraft paper, nylon films, polyester films, and coated and uncoated bonded nonwoven sheets of polyolefin film-fibrils of the type disclosed in 25 Steuber, U.S. 3,169,899. A commercial polyethylene film-fibril sheet product sold by E.I du Pont de Nemours and Company (Wilmington, DE) under the name Tyvek®, organic anti-stat coated Tyvek®, and vacuum metallized Tyvek® are particularly suitable. Tyvek® bonded 30 nonwoven polyethylene film-fibril sheets are lightweight and have outstanding mechanical properties such as puncture and tear strength, while also having good tolerance to ordinary weather conditions.

ė,

Ionomer/carbon monolayer films and multilayer laminates can be used as a wrapping material or formed into packages, such as bags. For example, two sheets of the multilayer laminate having their respective ionomer/carbon layers facing and contacting each other can be heat sealed together to form a bag by applying heat and pressure along their marginal edges using any of the procedures well known in the art. In addition to the EMI-shielding and moisture barrier properties of the metal foil layer, the resultant bag has an ionomer/carbon blend film inner surface that exhibits 10 a broad heat-seal temperature window, high heat seal seam strength, oil resistance, humidity insensitivity, low contamination, and permanent electrostaticdissipative functional performance. 15

The following examples further illustrate the production and performance of the composites and packaging material of the invention. Unless otherwise specified, amounts are in weight percent. Properties measured and measurement methods are listed below:

20

	Property Surface Resistivity	Measurement Method ASTM D-257
25		Sample films are conditioned in a glove box maintained at specified ambient relative humidities at room temperature for 24 hours before measurement.
30	Heat-Seal Strength	1" Flat Bar Sealer 400°F (204°C) bar temperature. 4-seconds dwell time 40 psi bar pressure The seam strength was measured with an Instron.

Oil-Resistance

The reported value is the average of three measurements. Federal Test Method 3015.1 and Military Specification MIL-B-81705C of 25 January

1989

Melt Index

ASTM D-1238. The melt-flowindex at 190°C is reported.

5

COMPARATIVE EXAMPLE

Seven percent by weight of Ketjenblack® EC600JD was melt-blended into 93% by weight of Surlyn® 1702 resin (a zinc ionomer derived from ethylene/methacrylic acid copolymers partially neutralized with zinc cations, having a melt index 16.2 decigrams/min., a density of 0.94 gms/cc, and melting point of 86°C (manufactured by E. I. du Pont de Nemours & Company, Inc., Wilmington, DE), with a 28 millimeter twin-screw extruder (Werner & Pfleiderer, Stuttgart, Germany) at a melt temperature of 191°C. The melt-blend was extruded into a 1/8" diameter strand and water-quenched and pelletized (melt-index = 0.3 decigrams/min.).

The pellets were subsequently melt-extruded in a 1"
Wayne table-top single-screw extruder (Wayne Machine and
Die Company, Totowa, NJ) and cast into a film with a 6"
horizontal film die. The cast film was quenched on a 3roll finisher. The resultant film was tested for surface
resistivity per ASTM D-257 at 12% ambient relative
humidity.

Surface Resistivity @12% RH (Ohms/square)	1.3 X 10 ⁵
Film Thickness (mils)	24
Film Take- Off Speed (FPM)	3.5
3-Roll Finisher Temperature #1 #2 #3 (°C) (°C) (°C)	35 35 35
Extruder Output (RPM)	30
Melt Temp (°C)	201-205
Sample	Ag Caron

The surface resistivity was marginally low for static-dissipative application. The concentration of carbon blended into the ionomer resin was too high.

5

EXAMPLE I

Fifty-seven (57) percent by weight of the 7%
Ketjenblack® EC600JD/93% Surlyn® 1702 pellets (melt-index

10 = 0.3 decigrams/min.) of the Comparative Example was
melt-blended into 43% by weight of Surlyn® 1702 (meltindex = 16.2 decigrams/min.) with a 28 millimeter twinscrew extruder (Werner & Pfleiderer, Stuttgart, Germany)
at a melt temperature of 187°C to obtain a final 4%

15 Ketjenblack® EC600JD/96% Surlyn® 1702 blend. The meltblend was extruded into a 1/8° diameter strand and waterquenched and pelletized (melt-index = 6.9
decigrams/min.).

The pellets were subsequently melt-extruded in a 1"

Wayne table-top extruder (Wayne Machine and Die Company,
Totowa, NJ) and cast into a film with a 6" horizontal
film die. The cast film was quenched on a 3-roll
finisher. The extruder-output and the film take-off
speed were adjusted to control the resultant film

thickness. The resultant films were tested for Surface
Resistivity per ASTM D-257 at 50% ambient relative
humidity.

Both films (1.5 mil thick and 4.0 mil thick) were static dissipative as shown by their surface resistivity values which were not only within the range of 10⁵ to 10¹² ohms/square but also within the preferred range of 10⁶ to 10¹⁰ ohms/square. Contamination properties of the films were tested by rubbing the inner surface of

the resultant film to a white Xerox paper surface and the films showed no carbon transfer.

Surface Resistivity 050% RH	3.4 × 108
Film Thickness (mils)	1.5
Film Take- Off Speed (FPM)	16
lsher re #3 (°C)	30
3-Roll Finisher Temperature #1 #2 #3 (°C) (°C) (°C)	30
3-Ro Tel #1 (°C)	30
Extruder Output (RPM)	15 15
Melt Temp (°C)	195 195
Sample No.	E E

PCT/US92/06805 WO 93/15142

15

EXAMPLE II

Packaging laminates with a carbon/ionomer blend inner surface were made by laminating a carbon/ionomer blend film with an intermediate layer of an ionomer film 5 onto the inner surface of an aluminum foil of an EMI shielding and moisture-barrier laminate. An Inta-Roto 24" film-laminator (Inta-Roto Machine Company, Model LCL18, Richmond, VA) was used for thermal lamination. A 2-mil MD230 O-dry ("A" wettable) aluminum foil 10 (made by Reynolds Metals Company, Richmond, VA) was first preheated in the drying tunnel at 100°F (37.8°C). The preheated foil was further heated by the chromesurface hot-roll (heated by 190°F (87.8°C) circulating oil) and laminated with a 2-mil ionomeric film 15 manufactured by Flex-O-glass, Inc., Chicago, Illinois prepared from Surlyn® 1605 ionomer resin (a sodium ionomer derived from ethylene/methacrylic acid copolymers partially neurtralized with sodium cations, having a melt index of 2.8 decigrams/min., a density of 20 0.95 gms/cc, and melting point of 86°C, manufactured by E. I. du Pont de Nemours & Co., Inc. Wilmington, DE) on the Teflon®-covered rubber nip roll side at the combining roll section. The nip pressure used was 100 psi. The laminate was then chilled (45°F (7.2°C) chill 25 roll temperature) and wound-up. The film and laminate speed was 25 feet per minute. The web tension was kept

The ionomer/foil laminate was fed through the
laminator a second time and preheated in the drying
tunnel at 100°F (37.8°C). The preheated laminate was
further heated by the chrome-surface hot-roll (heated by
190°F (87.8°C) circulating oil) with the foil side
contacting the hot-roll and laminated with the

carbon/ionomer blended film made in Example I on the Teflon®-covered rubber nip roll side. The nip pressure used was 100 psi. The laminate was then chilled (45°F (7.2°C) chill roll temperature) and wound-up. The film and laminate speed was 25 feet per minute. The web tension was again kept low.

The laminates were tested for Surface Resistivity at 12% ambient relative humidity (ASTM D-257), Oil-Resistance (FTM 3015.1), and Heat Seal Strength.

	Heat-Seal Seam Strength (gms/inch)	11,912
ination	Oil Resistance Test	Pass Pass
After-Lamination	Surface Resistivity @12% RH (Ohms/square)	3.7 x 10 ¹⁰ 4.8 x 10 ⁷
	Laminate Thickness (mils)	7.9
	Film Sample Number	IA IB
	Laminate sample Number	IIA

The resultant inner surface of the film/aluminum foil laminates were static dissipative as shown by their surface resistivity values which were within the range of 10⁵ to 10¹² ohms/square. Further, the laminates demonstrate good oil resistance and have very good heat-seal seam strength (i.e., all having values much greater than the industry standard of 1,590 grams/inch which is also required to meet Military Specification MIL-B-81705C (25 January 1989)). Contamination properties of the film were tested by rubbing the inner surface of the resultant laminate to a white Xerox paper surface showed no carbon transfer.

15

EXAMPLE III

Three ionomer/Ketjenblack® EC600JD carbon blends (3.0 % carbon/97 % Surlyn® 1702, 3.5 % carbon/96.5 % Surlyn® 1702, 20 and 4.0 % carbon/96 % Surlyn® 1702) were made by feeding Ketjenblack® EC600JD volumetrically from a K-Tron Twin-Screw Feeder (K-Tron Corporation, Pitman, NJ) and feeding Surlyn® 1702 from a K-Tron Weight-In-Loss Single Screw Feeder (K-Tron Corporation, Pitman, NJ) into the continuous mixer portion of a Farrel Compact Processor (using #7 blades) (Model CP-23 25 Farrel Machine Company, Ansonia, CT). The hot feed extruder portion received the continuous discharge from the mixer and extruded each blend through a die into four 1/8-inch diameter strands. The four strands were subsequently water-quenched and pelletized. Mixing conditions are listed in the table 30 below.

19

Mixing Conditions

5	Sample	Surlyn® 1702	Ketjen- black®	Mixer RPM	Rate	Chamber Temp.	Orifice Setting	Melt Temp	Melt Index (decigrams
	Blend #	EC600JD (%)	(%)	(RPM)	(PPH)	(°C)		(°C)	/min)
10	IIIA	97.0	3.0	350	100	140	7.0	171	9.8
15	IIIB IIIC IIID IIIE IIIF IIIG IIIH	96.5 96.5 96.5 96.5 96.5 96.5	3.5 3.5 3.5 3.5 3.5 3.5 3.5	350 350 350 350 550 350 500	100 50 75 100 100 100	140 150 150 150 150 150	7.0 9.5 9.5 9.5 9.5 7.5	169 176 177 176 168 172 174	9.2 9.8 8.3 9.1 9.3 9.2 8.7
20	IIIJ IIIK IIIL	96.0 96.0 96.0 96.0	4.0 4.0 4.0 4.0	350 350 350 500	75 100 100 100	150 150 150 150	9.5 9.5 7.5	169 168 173 174	8.0 8.4 8.0 8.4 in a 1"

The pellets were subsequently melt extruded in a 1"
Wayne table-top single screw extruder (Wayne Machine and Die
Company, Totowa, NJ) and cast into a film with a 6"
horizontal film die. The cast film was quenched on a 3-roll
finisher. Film casting conditions are listed in the
table below:

20

Film Casting Conditions

5	Sample Film #	Melt Temp. (°C)	Extruder RPM (RPM)		oll Fini emperatu #2 - (°C)		Film TakeOff Speed (FPM)	Film Thickness (mils)
10	IIIA.1 IIIA.2	170 190	19 19	58 58	58 58	53 53	12.5 12.5	2.0
15	IIIG.1 IIIB.1 IIIB.2 IIIC IIID	170 170 190 185 185	19 19 19 19 18	53 53 58 70 66	53 53 58 70 66	53 53 53 35	2.5 2.5 2.5 2.5	2.0 2.0 2.0 2.0
20	IIIE IIIF IIIG.2 IIIH	190 190 190 190	18 18 18 18	55 55 55, 55,	55 55 55 55	34 34 34 34 34	2.5 2.5 2.5 2.5 2.5	2.0 2.0 2.0 2.0 2.0
25	IIIJ.1 IIIK IIIM IIIJ.2	190 190 190 240	19	55 55 55 30	55 55 55 30	34 34 34 34	12.5 12.5 12.5 12.5	2.0 2.0 2.0 2.0

The surface resistivity was measured using ASTM D-257 after the resultant films were conditioned for 24 hours in 5%, 12%, and 50% ambient relative humidity at room temperature (22.2°C).

	Sample	Film Thick-	5% R.	н.	12% R	.H. 	n ohms/s	
	Film #	ness (mils)	Side 1	Side 2	Side 1	Side 2	Side 1	Side 2
5	IIIA.1 IIIA.2	2.0	15.5 16.4	15.1 16.4	16.2 18.0	15.9 16.8	16.0 15.4	15.1 15.2
10	IIIG.1 IIIB.1 IIIB.2 IIIC	2.0 2.0 2.0 2.0	14.6 15.9 7.8 8.9	13.6 15.7 7.8 8.6	14.3 16.2 8.0 8.6 6.6	13.7 15.9 7.8 8.3 6.5	14.3 15.2 7.8 8.9 6.5	14.3 15.2 7.5 8.2 6.4
15	IIID IIIE IIIF IIIG.2 IIIH	2.0 2.0 2.0 2.0 2.0	6.7 7.3 7.5 7.0 7.1	6.6 7.2 7.5 7.0 7.0	7.1 7.5 7.0 6.8	6.9 7.3 6.8 6.8	7.0 7.4 6.7 7.0	6.5 7.2 6.6 6.8
20	IIIJ.1 IIIK IIIM IIIJ.20	2.0 2.0 2.0 2.0	6.4 6.3 6.5 5.6	6.4 6.3 6.4 5.5	6.3 6.3 6.6 5.6	6.3 6.2 6.3 5.5	6.3 6.4 6.3 5.7	6.2 6.2 6.3 5.6

The surface resistivity of the static dissipative

film of this invention did not change significantly with

ambient relative humidity. Thus, these materials will

function over a wide range of ambient relative humidity

(i.e., they are humidity insensitive).

30 EXAMPLE IV

The pellets of Blend #IIIB (3.5% Ketjenblack® EC600JD and 96.5% Surlyn® 1702) were melt-extruded with a 2.5" single screw extruder, (manufactured by Sterling Extruder

Corporation, Linden, NJ) and cast into a 60-inch wide, and 2-mil thick film with a coat-hanger-design film die. The film takeoff and windup system was manufactured by Johnson Plastics Machinery, Chippewa Falls, WI.

C

÷

Extrusion conditions are as follows:

5	EXT	P (°	C)		TE		°C)			BARREL	DIE ADAP	EXTR UDER	FILM TAKE OFF	CHROME TEMP	ROLL
	1	2	3	4	1	2	3	4	5 .	°C	°C	RPM	FPM	CTR	BOTT.
10	198	198	204	200	185	182	181	185	1,83	180	180	30	10	65	60

Nine 4-inch diameter circular samples were taken across the 60 inch width of the last feet of the film. The nine 4-inch diameter circular samples were conditioned 24 hours at 12% ambient relative humidity and room temperature and their surface resistivity and film thickness profiles were measured using the test methods stated above.

POSITIONS OF 20 THE CENTER OF 4" DIA SAMPLES FROM LEFT 4" 11.5" 18" 25" 31" 37" 43.5" 49" 54 m 25 LOG (OF) SURFACE RESISTIVITY IN OHMS/SQUARE SIDE #1 13.1 14.3 8.6 6.9 7.0 9.1 12.1 12.1 30 13.4 SIDE #2 15.0 15.9 8.3 6.7 6.9 8.8 14.4 14.5 13.2 THICKNESS 2.0 2.4 2.2 2.3 2.0 2.0 2.3 2.5 1.9 (mil) 35

The center 23-inch width portion of the film was static dissipative as shown by the surface resistivity values which were between $10^{6.7}$ to $10^{9.1}$ ohms/square after 24 hour conditioning in a 12% ambient relative humidity at room temperature.

40

ţ

EXAMPLE V

The center 23 inch portion of the film of Example IV was slit into a new 23 inch wide film roll. A 24 inch wide flat coextrusion line custom built by SANO Inc (A subsidiary of Cincinnati Milacron, Inc. Cincinnati, OH) was used for extrusion-lamination. For this experiment, only one layer-slot of the multilayer coextrusion die was left open.

10 Fresh resin of Surlyn® 1702 was melt extruded into
19-inch wide, 1.0 mil thick adhesive layer between the 23
inch wide 2-mil thick Ketjenblack® EC600JD/Surlyn® 1702 blend
film of Example IV on the water-cooled chilled roll side and
a 24-inch wide, 2 mil thick O-dry surface aluminum foil on
the nip-roll side. The laminating conditions of the two 100feet laminate samples made were:

20	LAMINATE SAMPLE #	EXTRUDER MELT TEMP	SCREW RPM	HEAD PRESSURE (PSI)		LAMINATOR CHILL ROLL-TEMP	LINE SPEED (FPM)
	V-A	478F (247.8C)	36	543	475F (246.1C)	80F (26.7C)	200
.25	V-B	425F (218.3C)	51	1440	425F (218.3C)	80F (26.7C)	200

The two laminate samples were edge-trimmed to produce a 19-inch width center. Three 4-inch diameter circular samples (left-edge, center, and right-edge) were taken from each of the two laminate samples. After conditioning for 24 hours in a 12% ambient relative humidity at room temperature, the surface resistivity of the carbon/ionomer blend film surface of the six 4-inch diameter circular laminate samples were measured.

	Laminate Sample #	LOG OF SURFACE LEFT-EDGE	RESISTIVITY IN	N OHMS/SQUARE RIGHT-EDGE
5	V-A	8.4	7.2	7.7
	V-B	7.2	7.0	8.3

The surface resistivity was between 106.7 to 109.1 ohms/square before lamination; and between 107.0 to 108.4 ohms/square after extrusion lamination. These results showed that the surface resistivity was not affected significantly by the extrusion lamination condition used in this experiment. They are all within the static dissipative range of 105 to 1012 ohms/square.

Heat seal seam strength of the two laminate samples were measured to show the superior heat seal performance of the film-laminate of this invention. The sealing conditions are 4 second dwell time, bar temperature as noted, 40 psi bar pressure, 1-inch wide hot bar.

HEAT SEAL SEAM STRENGTH

SEALING TEMPERATURE		SEAM STRENGTH SAMPLE # V-B (gms/in)	SEAM STRENGTH SAMPLE # V-A (gms/in)	TYPE OF SEAL FAILURE
200F	(93.3C)	5,311	1,861	Peel
250F	(121.1C)	8,671	7,854	Laminate breaks
300F	(148.9C)	10,215	5,947	Laminate breaks
350F	(176.7C)	9,534	8,944	Laminate breaks
400F	(204.4C)	10,170	9,806	Foil breaks ther film peels from foil

A heat-seal seam strength of 1,590 grams/inch is considered good by industrial packaging standards and is

′ঙ

J

required by Military Specifications (MIL-B-81705C (25 Jan 1989)). These data show that film-laminates of this invention have a very wide window (200 to 400 degrees F or 93.3 to 204.4 degrees C) of heat seal temperature and a very high heat seal seam strength.

The resistance to ASTM #3 oil of the two laminate samples were also tested in accordance with the Federal Test Method 3015. The results are shown below:

LAMINATE SAMPLE #	Lamination Melt Temperature	Pass or Fail	Observations
V-A	475F (246.1C)	Pass	
V-B	425F (218.3C)	Fail	Blisters

An extrusion-lamination temperature of 475 degrees F (246.1 degrees C) provided sufficient adhesion to pass the Federal Test Method 3015 ASTM #3 Oil Delamination Test when one-mil thick Surlyn® 1702 is used as the adhesive layer between carbon/ionomer blend film and aluminum foil. The lower lamination temperature of 218.3 °C used to produce laminate sample V-B provided inadequate bond strength between the foil and adhesive layer.

CLAIMS

We claim:

- 1. An electrically dissipative composite consisting essentially of 97.5-95.5 wt % ionomer, and 2.5-4.5 wt % electroconductive carbon powder having a surface area of 1000-1500 m²/gm and a pore volume of 480-510 ml/100 gm.
- The composite of claim 1 wherein the ionomer
 comprises ethylene-acid polymer partly neutralized with metallic ions.
 - 3. The composite of claim 2 wherein the carbon powder has a surface area of about 1250 $\rm m^2/\rm gm$ and a pore volume of about 495 $\rm ml/100~\rm gm$.
- 4. An electrically dissipative package for protecting electrostatic-discharge sensitive items, said package comprising a continuous, heat-sealable, flexible sheet of the composite of claim 1.
- 5. An electrically dissipative package for protecting electrostatic-discharge sensitive items, said package comprising a continuous, heat-sealable, flexible sheet of the composite of claim 2.
- 6. An electrically dissipative package for protecting electrostatic-discharge sensitive items, said package comprising a continuous, heat-sealable, flexible sheet of the composite of claim 3.
 - 7. An electrically dissipative package for protecting electrostatic-discharge sensitive items, said package comprising a continuous layer of metal foil and a heat-sealable, flexible sheet of claim 1 adhered to one face of the metal foil layer, which face constitutes the inside of the package.
 - 8. An electrically dissipative package for protecting electrostatic-discharge sensitive items, said

PCT/US92/06805 WO 93/15142

27

package comprising a continuous layer of metal foil and a heat-sealable, flexible sheet of claim 2 adhered to one face of the metal foil layer, which face constitutes the inside of the package.

1

Q

5

- 9. An electrically dissipative package for protecting electrostatic-discharge sensitive items, said package comprising a continuous layer of metal foil and a heat-sealable, flexible sheet of claim 3 adhered to one face of the metal foil layer, which face constitutes the inside of the package.
- 10. An electrically dissipative package for protecting electrostatic-discharge sensitive items, said package comprising a continuous protective layer of a bonded nonwoven polyethylene film-fibril and a heat-sealable, flexible sheet of claim 1 adhered to one face of the protective layer, which face constitutes the inside of the package.

INTERNATIONAL SEARCH REPORT

Í

/06805

I. CLAS	SIFICATION OF SUBJECT MATTER	International Application No several classification symbols apply, indicate all) ⁴	PCT/US
Accordin	o to International Patent Classification (IPC) of C 08 L 23/08 C 08 V	several classification symbols apply, indicate all 4	
IPC ⁵ :	C 08 L 23/08,C 08 K	3/04, C 08 L 101/00, C 08	
II. FIELD:	S SEARCHED		3 J 5/18
Classification	on System j	um Documentation Searched 7	
. 5		Classification Symbols	
IPC ⁵	C 08 L,C 08 K,C	08 J,H 01 B,B 32 B	
	!		
	Documentation Sear	ched other than Minimum Documentation	
	to the Extent that such	Documents are included in the Fields Searched	
III. DOCUM	MENTS CONSIDERED TO BE RELEVAN		
ategory .	Citation of Document 11 with Last and	T.	
j	With indicated the	where appropriate, of the relevant passages 18	Referent to Claim No. 1
x	Derwent Accession	No	
	90-287 686 (38	NO.	1,4,5
	Telesytems (WI	PTI.) Derwort	7,9,1
	FWDIICations I	itd. London	
1	see abstract,		i
- 1	JP, A, 02-204	034 (OKURA	
- 1	INDUSTRIAL KK)		
	August 14, 199	00 (14.08.90).	
1	EP, A2, 0 219 315		
	(THE DOW CHEMT	CAL COMPANY)	1-10
	44 April 1987	(22.04.87)	
	see page 16, 1	ine 10 - page	*-
i	70, TIUE 70; D	age 21 lines	
	24-42; example claims.	s; fig.;	
.	oranis.		
.	EP, A2, 0 419 274		
	(DUPONT-MTTSIIT	POLYCHEMICALS	1-10
	CO. LTD.) 27 Ma	arch 1991	
	(47.03.91),	ļ	
!	see page 2, lir	ne 15 - page 3,	
!			
Special cates	gories of cited documents: 44	T faler document published after the	And a second second
	defining the general state of the art which is d to be of particular relevance	ched to wadenand the comme	with the application but
filing date	cument but published on or efter the internati	GUTT AAAAAAAAAAAAAAAAAAAAAAAAAAAAAAAAAAA	
document which is c	which may throw doubte on priority claim(e ited to establish the publication date of and other special research	"X" document of perticular relevance: cannot be considered novel or ca involve as inventive step	the claimed invention innet be considered to
citation or	other special reason (as specifically	iner ex decument of	
	felerring to an oral disclosure, use, echibitions	n or document is combined with one or	MAAUNAA BIAD MISAU SHA
	Bublished prior to the International filing date the priorny date Claimed	but In the ent.	one to a beleau eritted
ERTIFICAT		"4" document member of the same pale	nt (emily
	Completion of the International Search	I Date of the second	
	06.35	Date of Mailing of this international Searce	i i
elles d' 5		1 2 0 Ni	OV 1992
	ching Authority	Signature of Authorized Officer	VECI
EURO	OPEAN PATENT OFFICE		1
Tacasas		TENGLER e.h.	

-2	CONTINUED FROM THE SECOND SHEE	τι	4
II. DOCUM	ENTS CONSIDERED TO BE RELEVANT (CONTINUED FROM THE SECOND SHEE	Reierant to Claim No.	1
edota.	Challon of Document, 15 with Indication, with a appropriate appropriate and the challenge of the challenge o		
	line 20; page 4, lines 12-56; examples; claims.		
	line 20; page 1; 12-56: examples; claims.		
	12-30, 611-12		
	•		
1			
			1
		\	
			-
			l
}			1
1			1
1			1
	·'		
1			
1			
1			
1			
1			
		÷	
1	{		
,			
1			
1			
1		}	
1			
1			
1			
1		_	

AMHANG

JUNEXE

zum internationalen Recherchen-bericht über die internationale Patentanmeldung Nr.

to the International Search Report to the International Patent Application No.

au rapport de recherche inter-national relatif à la demande de brevet international n°

PCT/US 92/06805 SAE 63814

In diesem Anhang sind die Mitglieder der Patentfamilien der im obenge-

This Annex lists the patent family members relating to the patent documents nannten internationalen Recherchenbericht cited in the above-mentioned international en Recherchenbericht cited in the above-mentioned international search report. The Office is in no way liable for these particulars which are given merely for the purpose of information.

La présente annexe indique les membres de la famille de brevets relatifs aux documents de prevets cités dans le rapport de recherche international visée ci-dessus. Les reseignements fournis sont donnés à titre indication de la researche lité. tif et n'engagent pas la responsibilité de l'Office.

Im Recherchenbericht gangeführtes Patentdokument Patent document cited in search report Document de brevet cité dans le rapport de recherche	Datum der Veröffentlichung Publication date Date de	Mitglied(er) der Patentfamilie Patent family member(s)	de l'Office. Datum der Veröffentlichung Publication
	publication	Membre(s) de la famille de brevets	date Date de
EP A2 219315	22-04-87	AU A1 65253/86 AU B2 588397 BR A 8606907 CA A1 1289447 EP A3 2592315 JP T2 62502329 JP B4 4058786 KR B1 9101296 WB A1 8702333 US A 4906494 US A 4756414	publication 05-05-87 14-09-89 19-01-88 24-09-91 13-04-88 10-09-87 18-09-92 02-03-91 23-04-87 06-03-90 12-07-88 15-09-92
	27-03-91	CA AA 2025874 EP A3 419274 JP A2 3106954	22-03-91 18-03-92 07-05-91